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## FDMC035N10X1

## N-Channel PowerTrench® MOSFET 100 V, 5.5 A, 37 m $\Omega$

#### **Features**

- Max  $r_{DS(on)} = 37 \text{ m}\Omega$  at  $V_{GS} = 10 \text{ V}$ ,  $I_D = 5.5 \text{ A}$
- Max  $r_{DS(on)} = 41 \text{ m}\Omega$  at  $V_{GS} = 6 \text{ V}$ ,  $I_D = 5.0 \text{ A}$
- Low Profile 0.8 mm max in Power 33
- 100% UIL Tested
- RoHS Compliant

#### **General Description**

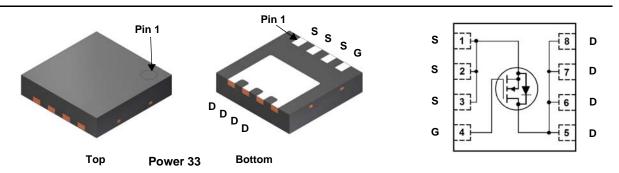
This N-Channel MOSFET is produced using ON Semiconductor's advanced PowerTrench® technology. This very high density process is especially tailored to minimize onstate resistance and optimized for hot swap application.

## **Applications**

- DC DC Conversion
- PSE Switch







## **MOSFET Maximum Ratings** T<sub>C</sub> = 25°C unless otherwise noted.

Symbol	Parame	eter		Ratings	Units
$V_{DS}$	Drain to Source Voltage			100	V
$V_{GS}$	Gate to Source Voltage			±20	V
	-Continuous	T <sub>A</sub> = 25°C	(Note 1a)	5.5	Δ.
ID	-Pulsed		(Note 4)	130	— A
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	181	mJ
D	Power Dissipation	T <sub>C</sub> = 25°C		50	W
$P_{D}$	Power Dissipation	T <sub>A</sub> = 25°C	(Note 1a)	2.3	VV
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Tempera	iture Range		-55 to +150	°C

#### **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	2.5	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient (Note 1a)	53	C/VV

#### **Package Marking and Ordering Information**

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMC035N10	FDMC035N10X1	Power 33	13"	12 mm	3000 units

## **Electrical Characteristics** T<sub>J</sub> = 25°C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Chara	acteristics					
$BV_{DSS}$	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \mu A$ , referenced to $25^{\circ}C$		107		mV/°C
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 80 V, V <sub>GS</sub> = 0 V			1	μΑ
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA

#### On Characteristics

V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \mu A$	2.0	2.5	4.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \mu A$ , referenced to 25°C		-7		mV/°C
r <sub>DS(on)</sub>		$V_{GS} = 10 \text{ V}, I_D = 5.5 \text{ A}$		30	37	
	Static Drain to Source On Resistance	$V_{GS} = 6 \text{ V}, I_D = 5.0 \text{ A}$		32	41	mΩ
		$V_{GS} = 10 \text{ V}, I_D = 5.5 \text{ A}, T_J = 125^{\circ}\text{C}$		60	75	
9 <sub>FS</sub>	Forward Transconductance	$V_{DS} = 5 \text{ V}, I_{D} = 5.5 \text{ A}$		18		S

#### **Dynamic Characteristics**

C <sub>iss</sub>	Input Capacitance	V 50 V V 0 V		1910	2675	pF
Coss	Output Capacitance	$V_{DS} = 50 \text{ V}, V_{GS} = 0 \text{ V},$ $V_{DS} = 10 \text{ Hz}$		109		pF
C <sub>rss</sub>	Reverse Transfer Capacitance	7 - 11/11/2		64		pF
$R_g$	Gate Resistance		0.1	2.6	5.2	Ω

#### **Switching Characteristics**

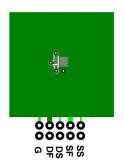
t <sub>d(on)</sub>	Turn-On Delay Time		12	21	ns
t <sub>r</sub>	Rise Time	$V_{DD} = 50 \text{ V}, I_D = 5.5 \text{ A},$	7	13	ns
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$	56	90	ns
t <sub>f</sub>	Fall Time		14	25	ns
$Q_{g}$	Total Gate Charge	V <sub>GS</sub> = 0 V to 10 V	41	58	nC
$Q_{g}$	Total Gate Charge	$V_{GS} = 0 \text{ V to 6 V}$ $V_{DD} = 50 \text{ V},$	27	38	nC
$Q_{gs}$	Gate to Source Charge	I <sub>D</sub> = 5.5 A	6.3		nC
$Q_{gd}$	Gate to Drain "Miller" Charge		11		nC

#### **Drain-Source Diode Characteristics**

$V_{SD}$	Source-Drain Diode Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 5.5 \text{ A}$ (Note 2)	8.0	1.3	V
t <sub>rr</sub>	Reverse Recovery Time	I <sub>F</sub> = 5.5 A, di/dt = 100 A/μs	42	68	ns
Q <sub>rr</sub>	Reverse Recovery Charge	1F = 5.5 A, αl/αt = 100 A/μs	58	92	nC

Notes

 $<sup>1.8</sup>_{\rm BJA}$  is determined with the device mounted on a 1in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material.  $R_{\rm BJC}$  is guaranteed by design while  $R_{\rm BCA}$  is determined by the user's board design.



a) 53°C/W when mounted on a 1 in² pad of 2 oz copper



b) 125°C/W when mounted on a minimum pad

- 2. Pulse Test: Pulse Width <  $300\mu\text{s},$  Duty cycle < 2.0%.
- 3.  $E_{AS}$  of 181 mJ is based on starting  $T_{J} = 25$  °C; N-ch: L = 3 mH,  $I_{AS} = 11$  A,  $V_{DD} = 100$  V,  $V_{GS} = 10$  V. 100% test at L = 0.1 mH,  $I_{AS} = 35$  A.
- 4. Pulsed Id please refer to Fig 11 SOA graph for more details.
- 5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

## **Typical Characteristics** $T_J = 25$ °C unless otherwise noted.

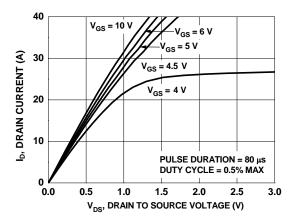


Figure 1. On Region Characteristics

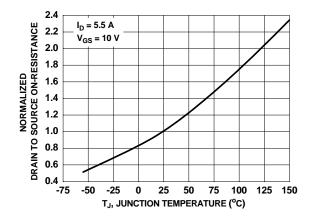


Figure 3. Normalized On Resistance vs. Junction Temperature

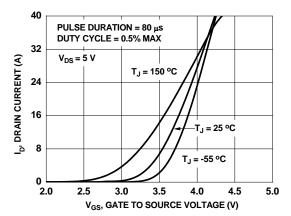


Figure 5. Transfer Characteristics

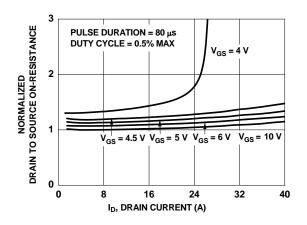


Figure 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

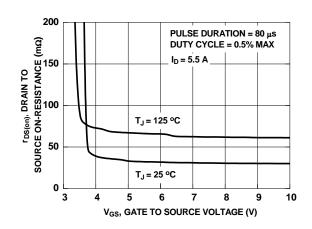


Figure 4. On-Resistance vs. Gate to Source Voltage

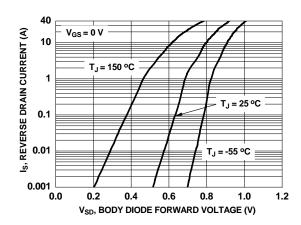


Figure 6. Source to Drain Diode Forward Voltage vs. Source Current

## **Typical Characteristics** $T_J = 25$ °C unless otherwise noted.

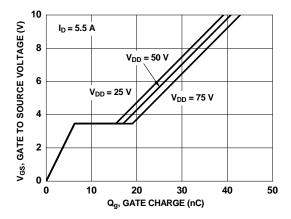


Figure 7. Gate Charge Characteristics

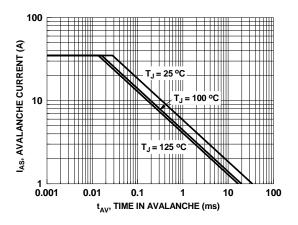


Figure 9. Unclamped Inductive Switching Capability

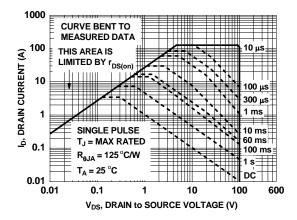


Figure 11. Forward Bias Safe Operating Area

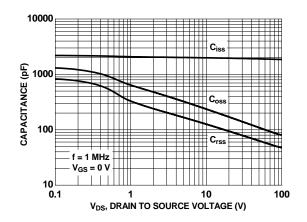


Figure 8. Capacitance vs. Drain to Source Voltage

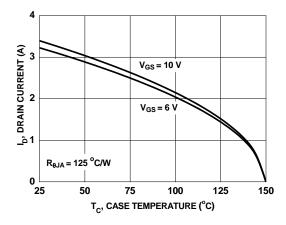


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

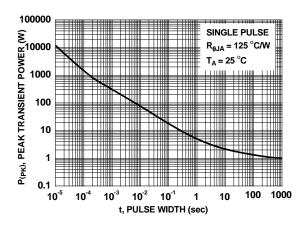


Figure 12. Single Pulse Maximum Power Dissipation

## **Typical Characteristics** $T_J = 25$ °C unless otherwise noted.

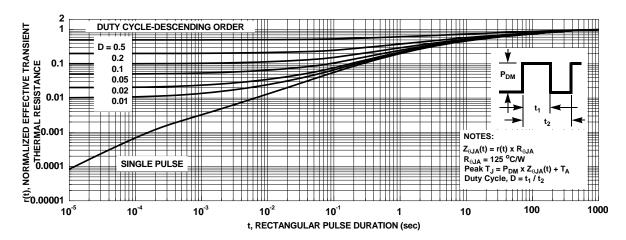
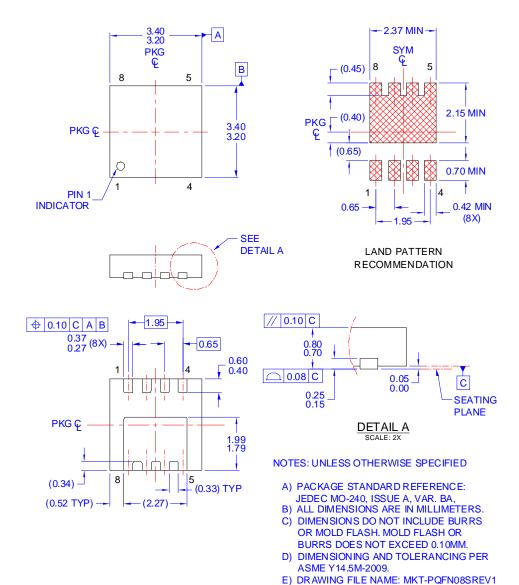


Figure 13. Junction to Ambient Transient Thermal Response Curve

## **Dimensional Outline and Pad Layout**



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